

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Hans-Jurgen Albrecht	10/31/2005
Klaus Heinrich Georg Bartl	01/03/2006
Werner Kruppa	11/03/2005
Klaus Muller	11/02/2005
Mathias Nowottnick	10/31/2005
Gunnar Petzold	10/31/2005
Klaus Wilke	10/31/2005
Klaus Wittke	10/31/2005
Hector Andrew Hamilton Steen	10/28/2005

RECEIVING PARTY DATA

Name:	Henkel Kommanditgesellschaft auf Aktien
Street Address:	Henkelstrasse 67
City:	Duesseldorf
State/Country:	GERMANY
Postal Code:	40589

Name:	Cookson Electronics Assembly Materials Group Alpha Metals Lotsysteme GmbH
Street Address:	Elisabeth-Selbert-Strasse 4
City:	Langenfeld
State/Country:	GERMANY
Postal Code:	40764

Name:	Stannol GmbH
Street Address:	Oskarstrasse 3-7
City:	Wupertal
State/Country:	GERMANY
Postal Code:	42283

PROPERTY NUMBERS Total: 1

501343484

PATENT
REEL: 025333 FRAME: 0446

CH \$40.00 10554274

Property Type	Number
Application Number:	10554274

CORRESPONDENCE DATA

Fax Number: (860)571-5028
Correspondence will be sent via US Mail when the fax attempt is unsuccessful.
 Email: trish.russo@us.henkel.com
 Correspondent Name: Henkel Corporation
 Address Line 1: One Henkel Way
 Address Line 4: Rocky Hill, CONNECTICUT 06067

NAME OF SUBMITTER:	Steven C. Bauman
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Total Attachments: 18
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ASSIGNMENT OF APPLICATION FOR PATENT

WHEREAS, we, Hans-Jürgen ALBRECHT, Klaus Heinrich Georg BARTL, Werner KRUPPA, Klaus MÜLLER, Mathias NOWOTTNICK, Gunnar PETZOLD, Klaus WILKE, Klaus WITTKE citizens of Germany and residents of Waxweiler Weg 13, 13051 Berlin, Germany; Niersstrasse 5, 45136 Essen, Germany; Von-Einem-Strasse 3, 45130 Essen, Germany; Destubener Strasse 6, 95448 Bayreuth, Germany; Laubestrasse 5, 01309 Gärtnerstrasse 10, 10245 Berlin, Germany; ~~Waxweiler Weg 13, 13051 Dresden~~, Germany; Lübbenauer Weg 7, 12527 Berlin, Germany; Wulfstrasse 11, 12165 Berlin, Germany and Hector Andrew Hamilton STEEN citizen of United Kingdom and resident of 211 Ebberns Road, Hemel Hemstead, Herts HP3 9RD, United Kingdom; respectively, have invented certain new and useful improvement in SOLDERING MATERIAL BASED ON SN AG AND CU for which we have made application for United States Letters Patent, said application having been filed as PCT international application number PCT/DE2004/000852 on April 21, 2004 designating the United States of America and various other countries; and

WHEREAS, Henkel Kommanditgesellschaft auf Aktien, Cookson Electronics Assembly Materials Group Alpha Metals Lötssysteme GmbH and Stannol GmbH corporations duly organized and existing under the laws of Germany and having a place of business at

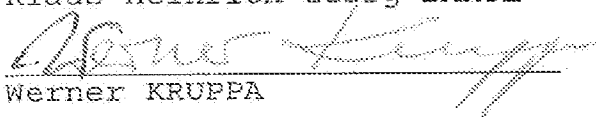
Henkelstrasse 67, 40589 Duesseldorf, Germany; Elisabeth-Selbert-
Strasse 4, 40764 Langenfeld, Germany and Oskarstrasse 3-7, 42283
Wupertal, Germany are desirous of acquiring the entire right,
title and interest in and to said invention, said application and
any and all Letters Patent which may issue thereon;

NOW, THEREFORE, to all whom it may concern, be it known that
we, the said Hans-Jürgen ALBRECHT, Klaus Heinrich Georg BARTL,
Werner KRUPPA, Klaus MÜLLER, Mathias NOWOTTNICK, Gunnar PETZOLD,
Klaus WILKE, Klaus WITTKE and Hector Andrew Hamilton STEEN for
good and valuable consideration, the receipt of which is hereby
acknowledged, do hereby sell, assign, transfer
and set over unto the said Henkel Kommanditgesellschaft auf
Aktien, Cookson Electronics Assembly Materials Group Alpha Metals
Lötssysteme GmbH and Stannol GmbH their successors and assigns,
the entire right, title and interest in and to said invention,
said application and any and all Letters Patent that may issue
thereon in the United States and any other country or countries
together with any division, divisions, extension or extensions,
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AND, we hereby authorize and request the Director of the
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Letters Patent which may issue upon said invention to said Henkel

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Materials Group Alpha Metals Lötssysteme GmbH and Stannol GmbH as
assignees of the entire right, title and interest in and to said
invention, said application and any and all Letters Patent that
may issue thereupon.

IN WITNESS WHEREOF, we have hereunto set our hand as of the
following date(s).

_____	Date _____
Hans-Jürgen ALBRECHT	
_____	Date _____
Klaus Heinrich Georg BARTL	
	Date <u>14/03/2005</u>
Werner KRUPPA	
_____	Date _____
Klaus MÜLLER	
_____	Date _____
Mathias NOWOTTNICK	
_____	Date _____
Gunnar PETZOLD	
_____	Date _____
Klaus WILKE	
_____	Date _____
Klaus WITTKE	
_____	Date _____
Hector Andrew Hamilton STEEN	

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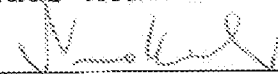
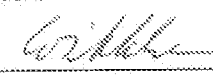
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<u>Werner KRUPPA</u>	Date _____
<u>Klaus MÜLLER</u>	Date _____
 <u>Mathias NOWOTTNICK</u>	Date <u>10/31/2005</u>
<u>Gunnar PETZOLD</u>	Date _____
<u>Klaus WILKE</u>	Date _____
 <u>Klaus WITKE</u>	Date <u>10/31/2005</u>
<u>Hector Andrew Hamilton STEEN</u>	Date _____

ASSIGNMENT OF APPLICATION FOR PATENT

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Henkelstrasse 67, 40589 Duesseldorf, Germany; Elisabeth-Selbert-Strasse 4, 40764 Langenfeld, Germany and Oskarstrasse 3-7, 42283 Wupertal, Germany are desirous of acquiring the entire right, title and interest in and to said invention, said application and any and all Letters Patent which may issue thereon;

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AND, we hereby authorize and request the Director of the United States Patent and Trademark Office to issue any and all Letters Patent which may issue upon said invention to said Henkel

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<u>Klaus Heinrich Georg BARTL</u>	Date _____
<u>Werner KRUPPA</u>	Date _____
<u><i>Klaus Müller</i></u> Klaus MÜLLER	Date <u>11/02/2005</u>
<u>Mathias NOWOTTNICK</u>	Date _____
<u>Gunnar PETZOLD</u>	Date _____
<u>Klaus WILKE</u>	Date _____
<u>Klaus WITTKE</u>	Date _____
<u>Hector Andrew Hamilton STEEN</u>	Date _____

ASSIGNMENT OF APPLICATION FOR PATENT

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<u>Klaus WITKE</u>	Date _____
<u><i>W.A.H. Steen</i></u> Hector Andrew Hamilton STEEN	Date <u>10/28/2005</u>

PATENT

Case H 06020 PCT/US

ASSIGNMENT OF APPLICATION FOR PATENT

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PATENT

REEL: 025333 FRAME: 0460

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<u>Klaus Heinrich Georg Bartl</u>	Date <u>01/03/2006</u>
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_____	Date _____
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Hans-Jürgen ALBRECHT Date 22.10.2005

Klaus Heinrich Georg BARTL Date _____

Werner KRUPPA Date _____

Klaus MÜLLER Date _____

Mathias NOWOTTNICK Date _____

Gunnar PETZOLD Date 31/10/2005

Klaus WILKE Date 31.10.2005

Klaus WITKE Date _____

Hector Andrew Hamilton STEEN Date _____